

Description

The AH3772 is a high-voltage, high-sensitivity Hall Effect latch IC designed for commutation of brushless DC motors, flow meters, linear encoders, and position sensors in industrial and consumer home appliances and personal care applications. To support a wide range of demanding applications, the design is optimized to operate over the supply range of 3.0V to 28V. With chopper-stabilized architecture and an internal bandgap regulator to provide temperature compensated supply for internal circuits, the AH3772 provides a reliable solution over the whole operating range. For robustness and protection, the device has a reverse-blocking diode with a zener clamp on the supply. The output has an overcurrent limit and a zener clamp.

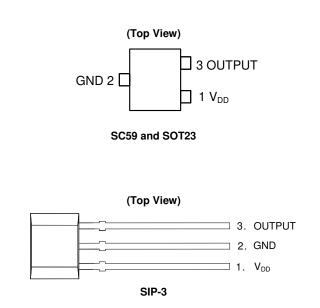
The single open-drain output can be switched on with South pole of sufficient strength and switched off with North pole of sufficient strength. When the magnetic-flux density (B) perpendicular to the package is larger than the operate point (B_{OP}), the output is switched on (pulled low). The output is held latched until magnetic-flux density reverses and becomes lower than the release point (B_{PP}).

Features

- · Bipolar Latch (South Pole: On, North Pole: Off)
- 3.0V to 28V Operating Voltage Range
- High Sensitivity: BOP and BRP of +25G and -25G Typical
- Single, Open-Drain Output with Overcurrent Limit
- Chopper-Stabilized Design Provides
 - Superior Temperature Stability
 - Minimal Switch-Point Drift
 - Enhanced Immunity to Stress
- Good RF Noise Immunity
- Reverse-Blocking Diode and Zener Clamp on Supply
- -40°C to +125°C Operating Temperature
- ESD (HBM): 6kV
- Industry Standard SC59, SOT23 and SIP-3 Packages
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Notes:

Pin Assignments



Applications

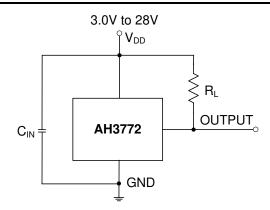
- Brushless DC Motor Commutation
- Revolution Per Minute (RPM) Measurement
- Flow Meters
- Angular and Linear Encoder and Position Sensors
- Contactless Commutation, Speed Measurement, and Angular Position Sensing/Indexing in Consumer Home Appliances, Office Equipment, and Industrial Applications

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Typical Applications Circuit (Note 4)



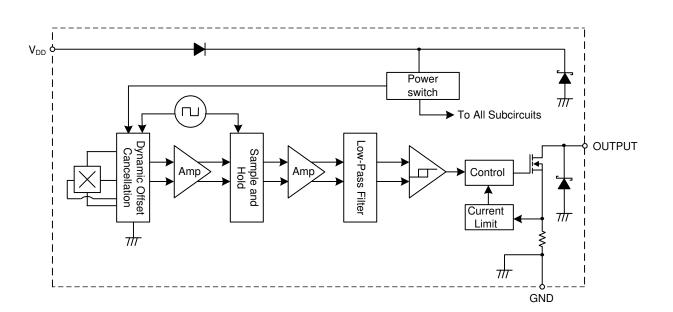
Note: 4. C_{IN} is for power stabilization and to strengthen the noise immunity, the recommended capacitance is 10nF ~ 100nF. R_L is the pull-up resistor.

Pin Descriptions

Package: SOT23 and SIP-3

Pin Number	Pin Name	Function
1	V _{DD}	Power Supply Input
2	GND	Ground
3	OUTPUT	Output Pin

Functional Block Diagram





Symbol	Characteristic		Value	Unit	
V _{DD}	Supply Voltage (Note 6)		32	V	
V _{DDR}	Reverse-Supply Voltage		-32	V	
VOUT_MAX	Output-Off Voltage (Note 6)		32V	V	
I _{OUT}	Continuous-Output Current	60	mA		
I _{OUT_R}	Reverse-Output Current		-50	mA	
В	Magnetic-Flux Density		Unlimited		
Р	Realizer Dever Dissipation	SIP-3	550	mW	
PD	Package Power Dissipation	SC59 and SOT23	230	mvv	
Ts	Storage Temperature Range		-65 to +165	°C	
TJ	Maximum Junction Temperature	+150	°C		
ESD	Electrostatic Discharge Withstand Capability—Human Body Mo	6	kV		

Absolute Maximum Ratings (Notes 5 & 6) (@T_A = +25°C, unless otherwise specified.)

Notes: 5. Stresses greater than the *Absolute Maximum Ratings* specified above can cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

6. The absolute maximum V_{DD} of 32V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum-rated conditions for any period of time.

Recommended Operating Conditions (@T_A = -40°C to +125°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V _{DD}	Supply Voltage	Operating	3.0 to 28	V
TA	Operating Temperature Range	Operating	-40 to +125	°C

Electrical Characteristics (Notes 7 & 8) (@T_A = -40°C to +125°C, V_{DD} = 3V to 28V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OUT_ON}	Output-On Voltage	$I_{OUT} = 20 \text{mA}, \text{ B} > \text{B}_{OP}$	—	0.2	0.4	V
IOUT_OFF	Output-Leakage Current	$V_{OUT} = 28V, B < B_{RP}, Output off$	—	<0.1	10	μA
	Supply Current	Output open, T _A = +25°C	_	3		mA
IDD		Output open, T _A = -40°C to +125°C	—	—	4	mA
Idd r	Reverse Rettern Current	$V_{DD} = -18V, T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	—	-0.01	1	mA
IDD_R	Reverse-Battery Current	$V_{DD} = -28V, T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	—	-0.01	1.5	mA
t _{ST}	Device Start-Up Time	$V_{DD} \ge 3V, B \ge B_{OP}$ (Note 7)	_	10	_	μs
fc	Chopping Frequency	$V_{DD} \ge 3V$	—	800	—	kHz
t _d	The time delay from magnetic threshold reached to the start of the output rise or fall	(Note 9)	_	3.75	_	μs
tr	Output Rising Time (external pull-up resistor R∟and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	_	0.2	1	μs
tf	Output Falling Time (Internal switch resistance and load capacitance dependent)	$R_L = 1k\Omega, C_L = 20pF$	_	0.1	1	μs
I _{OCL}	Output Current Limit	B>B _{OP} , (Note 10)	30	—	55	mA
Vz	Zener Clamp Voltage	I _{DD} = 5mA	28	_		V

Notes: 7. When power is initially turned on, Vob must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.

8. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control and characterization

9. Guaranteed by design, process control, and characterization. Not tested in production.

10. The device limits the output current $I_{\mbox{OUT}}$ to current limit of $I_{\mbox{OCL}.}$



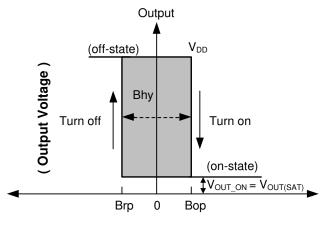
Magnetic Characteristics (Notes 11 &12) (T_A = -40°C to +125°C, V_{DD} = 3.0V to 28V, unless otherwise specified)

					(1mT=	10 Gauss)
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
P (South pole to part marking side)	Operation Point	$V_{DD} = 12V, T_A = +25^{\circ}C$	—	25	_	
B _{OP} (South pole to part-marking side)	Operation Point	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	10	25	40	
B _{RP} (North pole to part-marking side)	Deleges Deint	$V_{DD} = 12V, T_A = +25^{\circ}C$	_	-25	_	Gauss
	Release Point	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	-40	-25	-10	Gauss
	Liveteresis (Nets 12)	$V_{DD} = 12V, T_A = +25^{\circ}C$	_	50	_	
B _{HY} (B _{OPX} - B _{RPX})	Hysteresis (Note 13)	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	20	50	80	

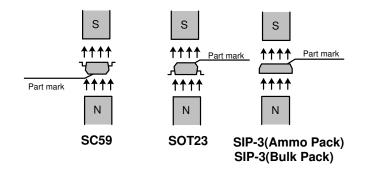
Notes: 11. When power is initially turned on, V_{DD} must be within its correct operating range (3.0V to 28V) to guarantee the output sampling. The output state is valid after the start-up time of 10µs typical from the operating voltage reaching 3V.

12. Typical values are defined at T_A = +25°C, V_{DD} = 12V. Maximum and minimum values over the operating temperature range is not tested in production but guaranteed by design, process control, and characterization.

13. Maximum and minimum hysteresis is guaranteed by design, process control, and characterization.



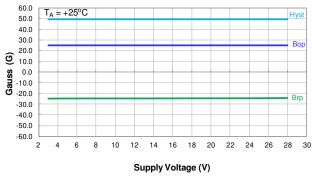
(Magnetic Flux Density B)



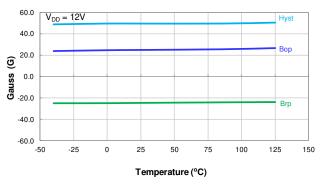


Typical Operating Characteristics

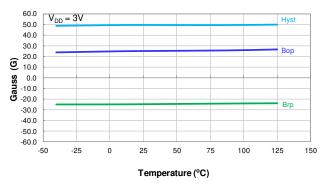
Magnetic Operating Switch Points-BOP and BRP



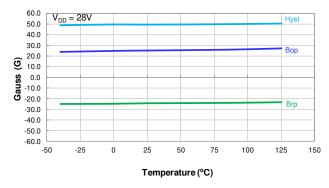
Switch Points BOP and BRP vs Supply Voltage



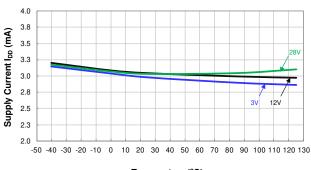
Switch Points BOP and BRP vs Temperature



Switch Points BOP and BRP vs Temperature



Switch Points BOP and BRP vs Temperature

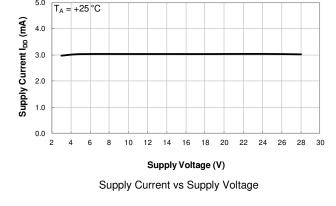


Temperature (°C)

Supply Current vs Temperature

Supply Current

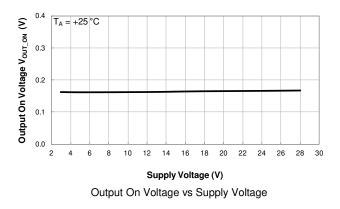
5.0

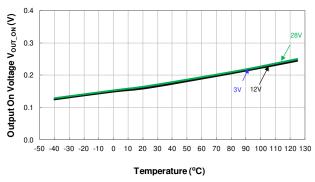




Typical Operating Characteristics (continued)

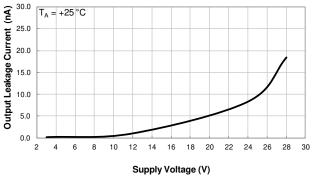
Output Switch On Voltage



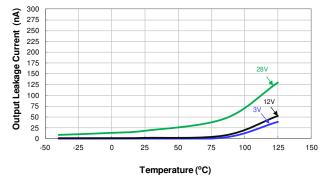


Output On Voltage vs Temperature

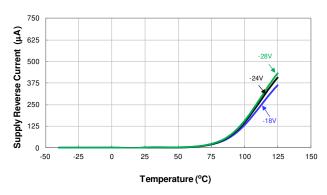
Output Switch Leakage Current



Output Leakage Current vs Supply Voltage

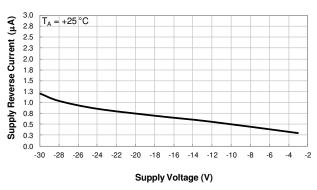


Output Leakage Current vs Temperature



Supply Reverse Current vs Temperature

Supply Reverse Current



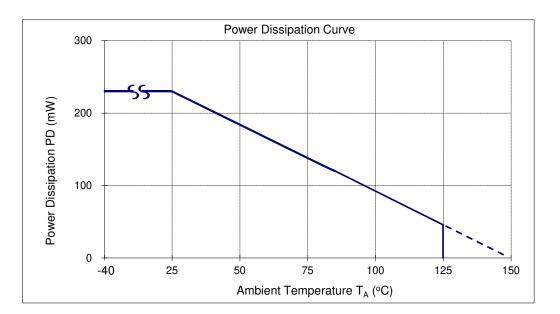
Supply Reverse Current vs Supply Voltage



Thermal Performance Characteristics

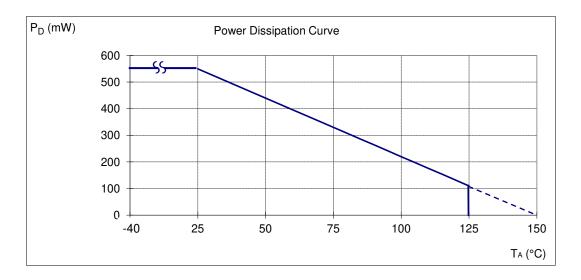
(1) Package types: SOT23 and SC59

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	83	74	55	46	37	18	0



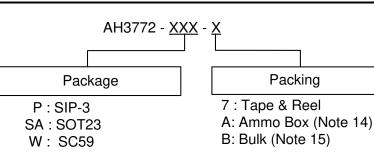
(2) Package type: SIP-3

T _A (°C)	25	50	60	70	80	85	90	100	105	110	120	125	130	140	150
P _D (mW)	550	440	396	362	308	286	264	220	198	176	132	110	88	44	0





Ordering Information

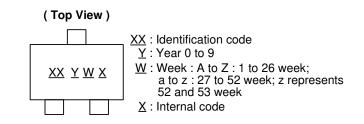


	Package	Packaging	B	Bulk 7" Tape and Reel Am		7" Tape and Reel		mo Box	
Part Number	Code	гаскаушу	Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix	
AH3772-P-A	Р	SIP-3	_	—	—	—	4000/Box	-A	
AH3772-P-B	Р	SIP-3	1000	-В	—	—	-	—	
AH3772-SA-7	SA	SOT23	_	—	3000/Tape & Reel	-7		—	
AH3772-W-7	W	SC59	_	—	3000/Tape & Reel	-7	—	—	

Notes: 14. Ammo Box is for SIP-3 Spread Lead. 15. Bulk is for SIP-3 Straight Lead.

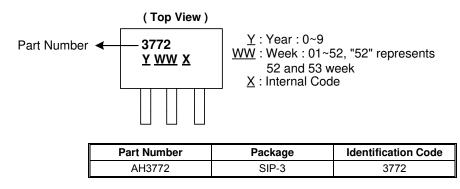
Marking Information

(1) Package Type: SOT23 and SC59



Part Number	Package	Identification Code
AH3772	SOT23	WV
AH3772	SC59	YV

(2) Package Type: SIP-3

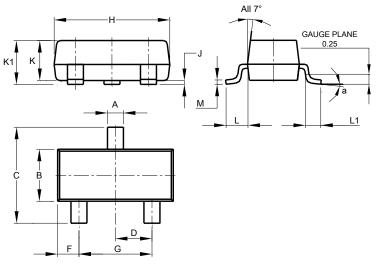




Package Outline Dimensions (All dimensions in mm.)

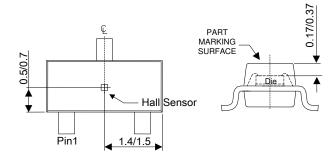
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT23



	SO	T23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
н	2.80	3.00	2.90
J	0.013	0.10	0.05
К	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а	0°	8°	
All	Dimens	ions in	mm

Min/Max

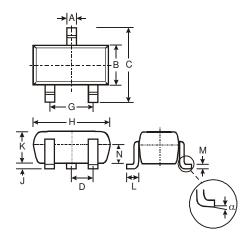




Package Outline Dimensions (cont.) (All dimensions in mm.)

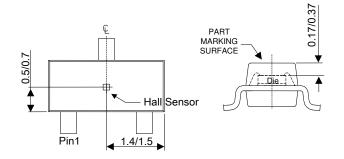
Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SC59



	SC	59	
Dim	Min	Max	Тур
Α	0.35	0.50	0.38
В	1.50	1.70	1.60
С	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
н	2.90	3.10	3.00
J	0.013	0.10	0.05
К	1.00	1.30	1.10
L	0.35	0.55	0.40
М	0.10	0.20	0.15
Ν	0.70	0.80	0.75
α	0°	8°	-
All D	Dimens	ions in	mm

Min/Max

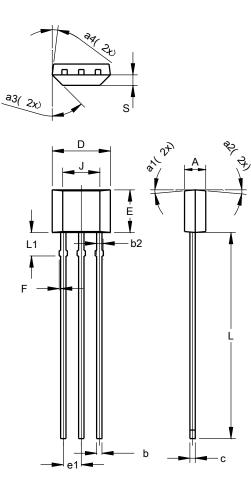




Package Outline Dimensions (continued) (All dimensions in mm.)

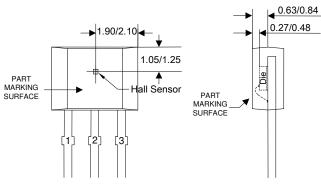
Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: SIP-3 Bulk



S	IP-3 (Bu	Ik Pack	()		
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
b	0.33	0.43	0.38		
b2	0.40	0.508	0.46		
С	0.35	0.41	0.38		
D	3.90	4.30	4.10		
Е	2.80	3.20	3.00		
e1	1.24	1.30	1.27		
F	0.00	0.20			
J	2	.62 REF	-		
L	14.00	15.00	14.50		
L1	1.55	1.75	1.65		
S	0.63	0.84	0.74		
a1			5°		
a2			5°		
a3			45°		
a4			3°		
All [Dimensi	ons in	mm		

Min/Max

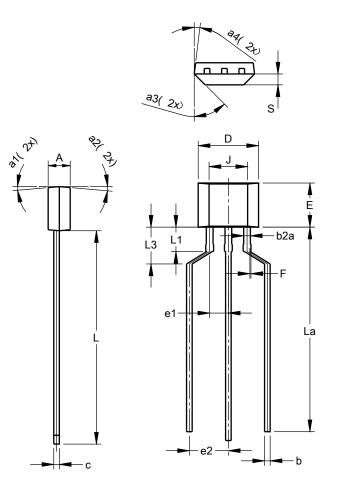




Package Outline Dimensions (cont.) (All dimensions in mm.)

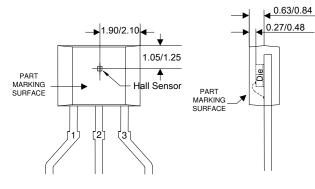
Please see http://www.diodes.com/package-outlines.html for the latest version.

(4) Package Type: SIP-3 Ammo Pack



SIP-3 (Ammo Pack)				
Dim	Min	Раск) Мах	Тур	
A	1.40	1.60	1.50	
b	0.33	0.43	0.38	
b2a	0.40	0.52	0.46	
С	0.35	0.41	0.38	
D	3.90	4.30	4.10	
Е	2.80	3.20	3.00	
e1	1.24	1.30	1.27	
e2	2.40	2.90	2.65	
F	0.00	0.20	_	
J	2.62 REF			
L	14.00	15.00	14.50	
La	12.90	14.90	13.90	
L1	1.55	1.75	1.65	
L3	2.00	3.00	2.50	
S	0.63	0.84	0.74	
a1	—	—	5°	
a2	—	—	5°	
a3	_	—	45°	
a4	_		3°	
All Dimensions in mm				

Min/Max

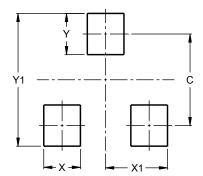




Suggested Pad Layout

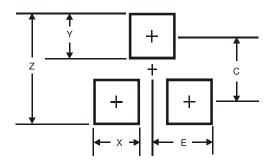
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

(2) Package Type: SC59



Dimensions	Value (in mm)
Z	3.4
Х	0.8
Y	1.0
С	2.4
E	1.35



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